

English [PRODUCTS](#) [APPLICATIONS](#) [DESIGN SUPPORT](#) [TRAINING](#) [SAMPLE & BUY](#) [ABOUT US](#) [Contact Us](#) [myMicrochip Login](#)Product Change Notification - JAON-13SZRI638 [\(Printer Friendly\)](#)**Date:** 24 Apr 2015**Notification subject:** CCB 1545 Initial Notice:Qualification of palladium coated copper with gold flash (CuPdAu) bond wire in selected products of the 160K wafer technology available in 8L TDFN package at NSEB assembly site**Notification text:** **PCN Status:**
Initial notification**Microchip Parts Affected:**

See attachments of affected catalog part numbers (CPN) labeled as...

[PCN_JAON-13SZRI638_Affected_CPN.xls](#)[PCN_JAON-13SZRI638_Affected_CPN.pdf](#)**Description of Change:**

Qualification of palladium coated copper with gold flash (CuPdAu) bond wire in selected products of the 160K wafer technology available in 8L TDFN package at NSEB assembly site.

NOTE: Selected products are non-automotive devices. Please review the affected CPN lists (attached) to identify the actual parts affected.

Pre Change:

Gold (Au) bond wire

Post Change:

Palladium coated copper with gold flash (CuPdAu) bond wire

Impacts to Data Sheet:

None

Reason for Change:

To improve manufacturability and qualify CuPdAu bond wire at NSEB assembly site.

Change Implementation Status:

In Progress

Estimated First Ship Date:

October 1, 2015 (date code: 1540)

NOTE: Please be advised that after the estimated first ship date customers may receive pre and post change parts.

Markings to Distinguish Revised from Unrevised Devices:

Traceability code

Revision History:**April 24, 2015:** Issued initial notification.

The change described in this PCN does not alter Microchip's current regulatory compliance regarding the material content of the applicable products.

Attachment(s): [PCN_JAON-13SZRI638_Qual_Plan.pdf](#)
[PCN_JAON-13SZRI638_Affected_CPN.pdf](#)
[PCN_JAON-13SZRI638_Affected_CPN.xls](#)Please contact your local [Microchip sales office](#) with questions or concerns regarding this notification.**Terms and Conditions:**If you wish to change your product/process change notification (PCN) profile please log on to our website at <http://www.microchip.com/PCN> sign into myMICROCHIP to open the myMICROCHIP home page, then select a profile option from the left navigation bar.To opt out of future offer or information emails (other than product change notification emails), click here to go to [microchipDIRECT](#) and login, then click on the "My account" link, click on "Update profile" and un-check the box that states "Future offers or information about Microchip's products or services."[Products](#) [Applications](#) [Design Support](#) [Training](#) [Sample & Buy](#) [About Us](#) [Contact Us](#)
[Legal](#) [Investors](#) [Careers](#)©Copyright 1998-2014 Microchip Technology Inc. All rights reserved.
Shanghai ICP Recordal No.09049794